SPECIFICATION FOR LCD MODULE

Model No. <u>TM162JCAWG1-1</u>

Prepared by:	Date:
Checked by :	Date:
Verified by :	Date:
Approved by:	Date:

TIANMA MICROELECTRONICS CO., LTD

REVISION RECORD

Date	Ver.	Ref. Page	Revision No.	Revision Items
08-04-28	1.0			

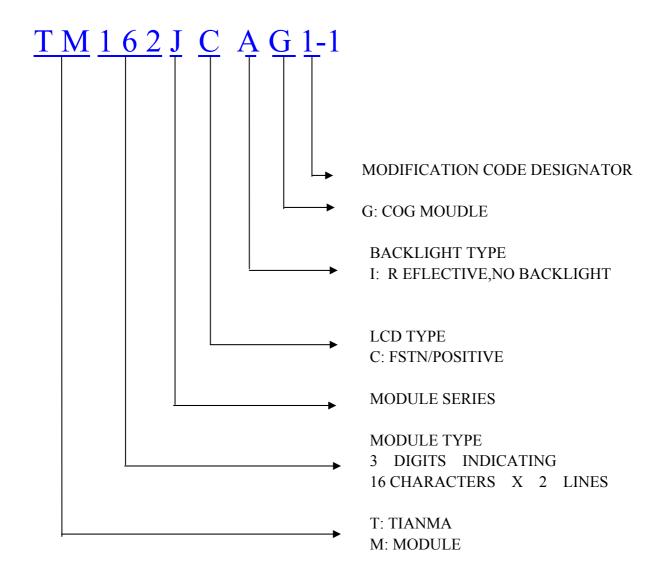
1. General Specifications:

-	
1.1 Display type:	FSTN
1.2 Display color*:	
Display color:	Blue-Black
Background:	White
1.3 Polarizer mode:	Reflective/Positive
1.4 Viewing Angle:	6:00
1.5 Driving Method:	1/16 Duty 1/5 Bias
1.6 LCD Operating Vol	tage: 3.3V
1.7 Logic Voltage:	3.3V
1.8 Without Backlight	
1.9 Controller:	NT7603H
1.10 Display Fonts:	$5 \times 8 \text{ dots} (1 \text{ Character})$
1.11 Data Transfer:	8 Bits Parallel
1.12 Operating Temper	ature: -20+60
Storage Temperat	ure: -30+70
1.13 Outline Dimension	ns: Refer to outline drawing on next page
1.14 Dot Matrix:	16 Characters X 2 Lines
1.15 Dot Size:	0.55X0.60(mm)
1.16 Dot Pitch:	0.60X0.65(mm)
1.17 Weight:	20g (Approx)

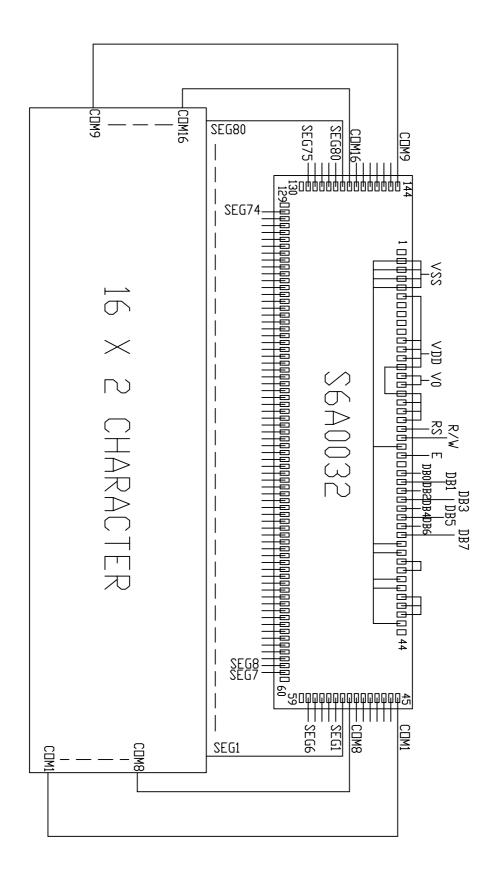
* Color tone is slightly changed by temperature and driving voltage.

NOTES:1.DISPLAY TYPE:FSTN MDE2.VIEWING DIRECTION: 3.POLARIZER MODE:FSTN MDE4.OPERATING TEMP: 5.STORAGE TEMP: 6.VDD: 7.LCD OPERATING VOLTAGE:-20°C+60°C -30°C+70°C3.3V 7.LCD OPERATING VOLTAGE:3.3V 3.3V7.LCD OPERATING VOLTAGE: 9.CONTROLLER: 10.PIN CONNECTOR 11.THE CONTROLLED DIMENSIONS MUST TO BE 12.ALL UNMARKED TOLERANCES: ±0.3mm 13.REQUIREMENTS ON ENVIRONMENTAL PROTECTION: ROHS	1 2 3 4 5 6 7 8 9 10 11 12 Vss NC VDD RS R/W E DB0 DB1 DB2 DB3 DB4 DB5 I	$\begin{array}{c} & \begin{array}{c} & \begin{array}{c} & \\ & \\ & \end{array} \end{array} \\ & \bigg) \\ \\ & \bigg) \\ \\ & \bigg) \\ \\ & \bigg) \\ \\ & \bigg) \\ \\ \\ & \bigg) \\ \\ & \bigg) \\ \\ \\ & \bigg) \\ \\ \\ \\ & \bigg) \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ $	
DRAWN APPROVED CONFTRMED BY:	13 14 DB6 DB7	SKE-1 2.00(MAX) FRONT 0.70±0.10	Rev
TITAN-MA MICROELECTRONICS CO. 22/F., HANGDU Building, Sheman Road, Central, Shenzhen, China BY: DWG NO: SKE-1		New release. 9.45±0.50 0.10 0.70±0.10	Description
Shenzhen, China Scale: UNIT: mm SHEET NO: 1 OF 1			Date

3. LCD Module Part Numbering System



4. Circuit Block Diagram



5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	Vdd - Vss	-0.3	7.0	V	
LCD Driving Voltage	VLCD	-0.3	8.0	v	
Operating Temperature Range	Тор	-20	+60		No
Storage Temperature Range	Тѕт	-30	+70		Condensation

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics

Iter	n	Symbol	Min.	Тур.	Max.	Unit
Supply V (Log	-	Vdd - Vss	3.0	3.3	3.6	V
	Deply Voltage VLCD VLCD		3.3			
Input	High	V _{IH} (V _{DD} =3.3)	$0.7 \mathrm{V_{DD}}$	-	V_{DD}	V
Signal Voltage	Low	V _{IL} (V _{DD} =3.3)	V _{SS}	-	0.3V _{DD}	V
Supply c (Log		I_{DD} (VDD - VSS = 3.3)	50	-	150	μΑ

6.2 Interface Signals

Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	NC		
3	V_{DD}	3.3V	Power supply voltage for LCD
4	RS	H/L	Selects registers (H: Data, L: Instruction)
5	R/W	H/L	Selects read or write (H: Read, L: Write)
6	Е	H/L	Read/write enable signal
7	DB0	H/L	Data bit0
8	DB1	H/L	Data bit1
9	DB2	H/L	Data bit2
10	DB3	H/L	Data bit3
11	DB4	H/L	Data bit4
12	DB5	H/L	Data bit5
13	DB6	H/L	Data bit6
14	DB7	H/L	Data bit7

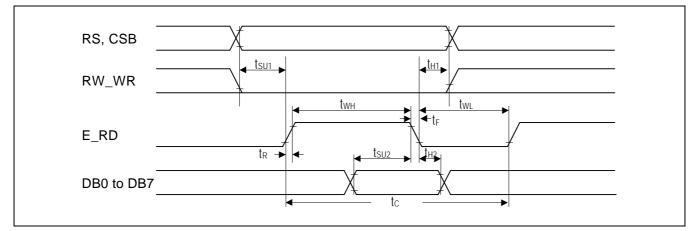
6.3 Interface Timing Chart

AC Characteristics(VDD=2.4V~5.5V,Ta=-30~+85°C)

6800-series MPU Interface & Write Instruction

Condition	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E cycle time	t _C	650		-	
	Pulse rise / fall time	t _R , t _F	-	-	25	
	E pulse width high	t _{WH}	450	-	-	
VDD = 2.4V to 3.6V,	E pulse width low	t _{WL}	150	-	-	20
Ta = -30 to +85 °C	RS and CSB setup time	t _{SU1}	60	-	-	ns
	RS and CSB hold time	t _{H1}	30	-	-	
	DB setup time	t _{SU2}	100	-	-	
	DB hold time	t _{H2}	50	-	-	
	E cycle time	t _C	350		-	
	Pulse rise / fall time	t _R , t _F	-	-	25	
	E pulse width high	t _{WH}	250	-	-	
VDD = 3.6V to 5.5V,	E pulse width low	t _{WL}	100	-	-	20
Ta = -30 to +85 °C	RS and CSB setup time	t _{SU1}	40	-	-	ns
-	RS and CSB hold time	t _{H1}	10	-	-	
	DB setup time	t _{SU2}	40	-	-	
	DB hold time	t _{H2}	10	-	-	

AC Characteristics (6800-series Write Instruction)

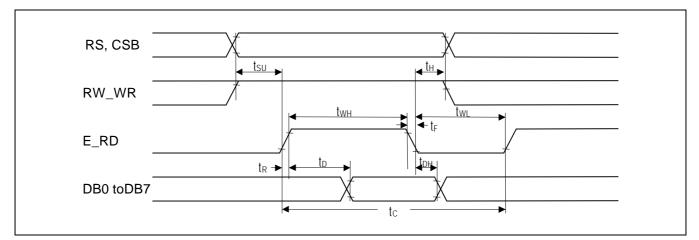


Write Bus Mode Timing (6800-series MPU Interface)

6800-series MPU Interface & Read Instruction

Condition	Characteristic	Symbol	Min.	Тур.	Max.	Unit	
	E cycle time	t _C	650		-		
	Pulse rise / fall time	t _R ,t _F	-	-	25		
	E pulse width high	t _{WH}	450	-	-		
VDD = 2.4V to 3.6V,	E pulse width low	t _{WL}	150	-	-		
Ta = -30 to +85 °C	RS and CSB setup time	t _{su}	60	-	-	ns	
	RS and CSB hold time	t _H	30	-	-		
	DB output delay time	t _D	-	-	360		
	DB output hold time	t _{DH}	20	-	-		
	E cycle time	t _C	350		-		
	Pulse rise / fall time	t _R ,t _F	-	-	25		
	E pulse width high	t _{WH}	250	-	-		
VDD = 3.6V to 5.5V,	E pulse width low	t _{WL}	100	-	-		
Ta = -30 to +85 °C	RS and CSB setup time	t _{su}	40	-	-	ns	
	RS and CSB hold time	t _H	10	-	-		
	DB output delay time	t _D	-	-	120		
	DB output hold time	t _{DH}	10	-	-		

AC Characteristics (6800-series Read Instruction)





6.4 Instruction Code

INSTRUCTION DESCRIPTION

Instruction	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description		
*Clear display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to "00H" from AC
Return home	0	0	0	0	0	0	0	0	1	-	DDRAM address is set to 00h from AC and the cursor returns to 00h position. The contents of DDRAM are not changed.
Entry mode set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display
Display ON / OFF control	0	0	0	0	0	0	1	D	С	в	Set display (D), cursor (C), and blinking of cursor (B) ON / OFF control
Cursor or display shift	0	0	0	0	0	1	S/C	R/L	-	-	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data
Function set	0	0	0	0	1	DL	-	-	-	-	Set interface data length (DL: 4-bit / 8-bit) instruction
CGRAM address set	0	0	0	1	0	0	A3	A2	A1	A0	Set CGRAM address in address counter.
DDRAM address set	0	0	1	A6	A5	A4	A3	A2	A1	A0	Set DDRAM address in address counter.
Read busy flag and address	0	1	BF	A6	A5	A4	A3	A2	A1	A0	Whether in internal operation or not can be known by reading BF, The contents of address counter can also be read
Write data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into DDRAM / CGRAM
Read data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from DDRAM / CGRAM

Instruction Table

("-": Don't care)

NOTES:

1. Instruction execution time depends on the internal process time of KS0032, therefore it is necessary to provide a time larger than one MPU interface cycle time (tc) between execution of two successive instructions.

2. "Clear Display" instruction has 850µs execution time (when fosc = 40.0kHz), so check the Busy flag or wait for more than 850µs after using "Clear Display" instruction.

6.5 Character generator ROM(S6A0032)

CHARACTER GENERATOR ROM (CGROM)

CGROM has 5 x 8-dot 254 characters. The CGROM character code 00h and 01h are CGRAM character data area.

CGROM Character Code (00)																
Upper 4bit Lower 4bit		LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	ĦLL	HLLH	HLHL.	HL.HH	HHLL	HHLH	HHHL.	нннн
LLLL	CGRAN CHAR #1			Ø	ð			P					5			P
LLLH	CGRAN CHAR #2				H	Q										
LLHL	Ĥ	· · · · · · · · · · · · · · · · · · ·						F		1					B	
LLHH	B							5						Ŧ		••••••••••••••••••••••••••••••••••••••
LHLL					\square											
LHLH	D	5			· · · ·							T			5	
LHHL	Ε		8.	6											P	
LHHH	H						9								9	π
HLLL	E											-7				
HLLH					I					2:		-T		ĨĻ		
шш								Z						L		
н.нн		H			K					15		**				5
HHLL	••	H													4	
HHLH							ΓΊ			ki	1	3				
HHHL.			•				ŗ				3		1			
HHHH															Ö	

CGROM Character Code (00)

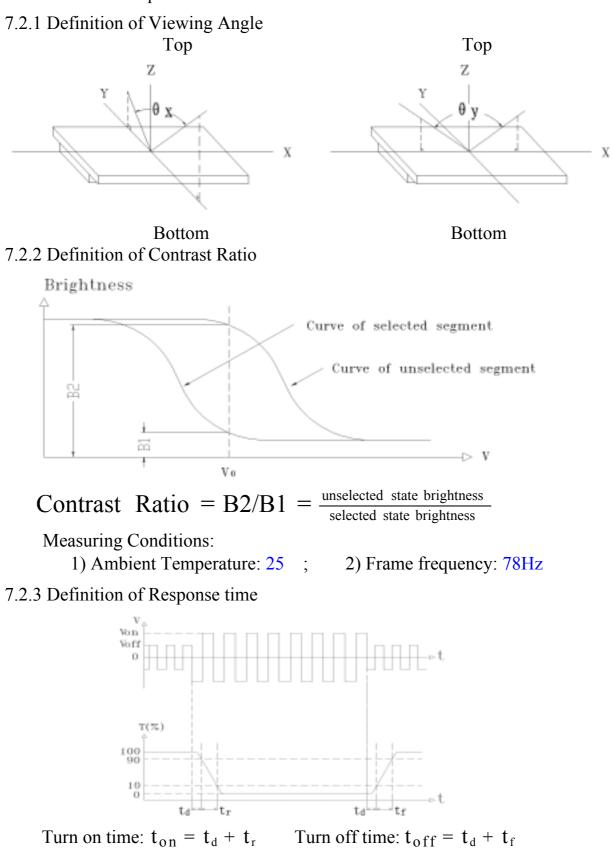
7. Optical Characteristics

7.1 Optical Characteristics

Ta=25

7.1 Opti cu					14 2			
Item		Symbol	Con	dition	Min.	Тур.	Max.	Unit
Viewing Angle		x	Cr≥2	y=0 °	-35		20	Dog
		у	Cr≥2	_x =0 °	-30)	30	Deg
Contrast Ratio		Cr	x= y=	=0 ° =0 °	4.0	-	-	
Response	Response Turn ,		x=	$x=0 \circ$ $y=0 \circ$		-	250	ma
Time	Turn off	T _{off}	y=	=0 °	-	-	250	ms

7.2 Definition of Optical Characteristics



Measuring Condition:

1) Operating Voltage: 3.3V

2) Frame frequency: 78Hz

8. Reliability

8.1	Content of Reliabilit	Ta=25	
No.	Test Item	Content of Test	Test condition
1	High Temperature	Endurance test applying the high	70
	Storage	storage temperature for a long time	96H
2	Low Temperature	Endurance test applying the low	-30
	Storage	storage temperature for a long time	96H
	High Temperature	Endurance test applying the high	40
3	/Humidity Storage	temperature and high humidity	90%RH
	Thumany Storage	storage for a long time	96H
		Endurance test applying the low	
	Temperature	and high temperature cycle	20 /(0
4		-20 25 60 25	-20 /60
	Cycle	30min 5min 30min 5min	10 cycles
		1 cycle	
	Vibratian Test	Endurance test englying the	10Hz~150Hz,
5	Vibration Test (package state)	Endurance test applying the vibration during transportation	$50 {\rm m/s}^2$,
	(package state)	vioration during transportation	40min
	Shock Test	Endurance test applying the shock	Half- sine wave,
6	(package state)	during transportation	100m/s^2 ,
	(puerruge stute)		11ms
	Atmospheric	Endurance test applying the	40kPa
7	Pressure Test	atmospheric pressure during	40KI a 16H
		transportation by air	1011

8.2 Failure Judgment Criterion

Criterion	Test Item No.).		Eailura Judgament Criterian
Item	1	2	3	4	5	6	7	Failure Judgement Criterion
Basic Specification								Out of the basic Specification
Electrical specification								Out of the electrical specification
Mechanical Specification								Out of the mechanical specification
Optical Characteristic								Out of the optical specification
Note For test item refer to 8.1								
Remark	Basic specification = Optical specification + Mechanical specification							

9. QUALITY LEVEL

Examination	At Ta=25	Inspection						
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL		
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See Appendix A			II	Major 1.0 Minor 2.5		
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See Appendix B II 1.0			Minor			
Note: Major defects: Open segment or common, Short, Serious damages, Leakage Miner defects: Others Sampling standard conforms to GB2828								

10. Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : $0 \sim 40$ Relatively humidity:80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix A

Inspection items and criteria for appearance defects

Items	Items Contents		Criteria			
Protective Glue	No clear defects					
Cover Tape		Covering all of the chip and no clear crimple				
Leakage	Not permitted					
Rainbow		According to	the lir	nit specimen		
	Wrong polarizer attachment	Not permitted				
Polarizer	Bubble between	Not counted	ed Max. 3 defects a		ıllowed	
	polarizer and glass	φ<0.3mm 0.3mm φ 0.5		0.3mm ø 0.5r	ōmm	
	Scratches of polarizer	According to the limit specimen				
Black spot		Not counted	Max	. 3 spots allowed		
(in viewing area)		X<0.20mm	0.201	mm X 0.5mm	Max. 3	
	r	X=(a+b)/2			spots (lines)	
Black line (in viewing	+	Not counted			allowed	
area)	d b	a<0.02mm	0.02	mm a 0.05mm		
			b 2.0mm			
Progressive cracks		Not permitted	l			

Appendix A

Inspection item and criteria for appearance defects (continued)

Contents				Criteria		
Cracks on pads	а	b		с	Max. 2 Cracks allowed	
	3mm	W	V/5	T/2		
	2mm	W	V/5	T/2 <c<t< td=""></c<t<>		
Cracks on contact side	a			b		
	3m	m T/2		T/2		
	2m	m]	Г/2 <b<t< td=""><td></td><td></td></b<t<>		
	C shall be not reach the seal area			Max. 2 cracks	Max. 5 cracks allowed	
Cracks on non-contact side	а		b		allowed	
	3m	m		T/2		
	2m	m	J	[/2 <b<t< td=""><td></td></b<t<>		
	C 0.5mm					
	d SW/3					
Corner cracks	e<2.0mm ² f<2.0mm ²			Max. 3 cracks allowed		
	Cracks on pads Cracks on contact side Cracks on non-contact side Cracks on non-contact side	Cracks on padsaImage: Cracks on contact side3mmCracks on contact sideaImage: Cracks on non-contact side3mmCracks on non-contact side3mmCracks on non-contact sideaImage: Cracks on non-contact sideaImage: Cracks on non-contact side3mmImage: Cracks on non-contact side3mmImage: Cracks on non-contact side3mmImage: Cracks on non-contact sideaImage: Cracks on non-contact side3mmImage: Cr	Cracks on padsab $3mm$ $3mm$ W $2mm$ $2mm$ W $2mm$ $3mm$ W $Cracks on contact sidea3mm2mm2mm2mmCracks on non-contact sideaCracks on non-contact sideaC shall be not area3mmC not contact sideaC not contact side$	Cracks on padsab $3mm$ $W/5$ $2mm$ $W/5$ $2mm$ $W/5$ $Cracks on contact sidea3mm3mmCracks on contact side3mmCshall be not reactareaCracks on non-contact sideaCracks on non-contact side3mmCorner cracksCorner cracksCorner crackse<2.0mm^2$	Cracks on padsabc $3mm$ $W/5$ $T/2$ $2mm$ $W/5$ $T/2 < C < T$ $2mm$ $W/5$ $T/2 < C < T$ $Cracks on contact sideab3mmT/22mmT/2 < b < T2mmT/2 < b < T2mmT/2 < b < TCracks on non-contact sideaabCracks on non-contact sideaabaT/2 < b < TaT/2 < b < Taaaaaaabaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaaa$	Cracks on padsabcMax. 2 $1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\$

Appendix B

Inspection items and criteria for display defects

Items	Items Contents		Criteria			
Open segment or open common			Not permitted			
Short			Not permitted			
Wrong viewi	ing angle	;	Not permitted			
Contrast radi	o unever	1	According to	the limit specimen		
Crosstalk			According to	the limit specimen		
	-	1 1-a	Not counted	Max.3 dots allowed		
	KS D		X<0.1mm	0.1mm X 0.2mm		
Pin holes		X=(a+b)/2	Max.3 dots			
and cracks in segment		Not counted	Max.2 dots allowed	allowed		
(DOT)		A<0.1mm	0.1mm A 0.2mm			
			D<0.25mm			
Black spot	k spot		Not counted	Max.3 spots allowed		
(in viewing area)			X<0.1mm	0.1mm X 0.2mm		
urou)			X=(a+b)/2			
Black line	÷		Not counted	Max.3 lines allowed	(lines) allowed	
(in viewing area)			a<0.02mm	0. 02m a 0.05mm b 0. 5mm		

Appendix B

Inspection items and criteria for display defects (continued)

Items	Content	Criteria		
	-1-0	Not counted	Max. 2 defects allowed	
		x < 0.1mm	0.1mm x 0.2mm	
		x=(a+b)/2		– Max.3
	D→t⊨a	Not counted	Max. 1 defects allowed	defects
Transfor- mation of segment		a < 0.1mm	0.1mm a 0.2mm D>0	allowed
		Max.2 defects 0.8W a 1.2 a=measured va W=nominal va	2W alue of width	